

RECOMMENDED P.C.B LAYOUT

ROHS COMPLIANT

DESCRIPTION: 0.085 RIBBON - DIP SOLDER

区

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DRAWN:
WAYNE ROBBINS
DATE:
09/15/2005

SPECIFICATIONS:

ELECTRICAL:

CURRENT RATING:

INSULATION RESISTANCE:

DIELECTRIC WITHSTANDING VOLTAGE: CONTACT RESISTANCE:

OPERATING TEMPERATURE:

MATERIALS:

INSULATION: PBT, UL 94 V-O RATED
CONTACTS: PHOSPHOR BRONZE
CONTACT PLATING: GOLD FLASH IN MATING AREA

BRIGHT TIN IN SOLDER AREA

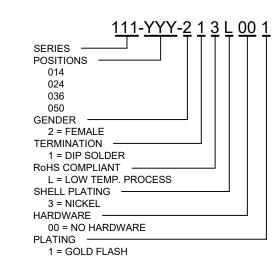
1 AMPS

30 m Ω MAX.

-55°C TO +105°C

1,000 MΩ MIN. @ 500 VDC 1,000 VAC FOR 1 MINUTE

SHELL: STEEL, NICKEL PLATED



UNITS = mm

DO NOT SCALE FROM DRAWING

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SCALE: SHEET OF REV 10 10 111-YYY-213L001

